



IFW AF  
566.43481CC4  
Expedited Procedure  
Group: 2813

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): N. Fukutomi, et al.

Appln. No. 10/042,408

Filed: January 8, 2002

For: FABRICATION PROCESS OF SEMICONDUCTOR PACKAGE AND  
SEMICONDUCTOR PACKAGE

Group: 2813

Examiner: N. Berezny

**AMENDMENT AFTER FINAL REJECTION**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

August 13, 2004

Entered  
w/RCE  
9/20/04  
C. Per

Sir:

In response to the Office Action mailed May 13, 2004, please amend the  
above-identified application as listed in the following, and as set forth on the  
following pages:

Amendments to the Claims; and

Remarks are included following the amendments.